Field Effect Transistor

Silicon N Channel MOS Type (π-MOS II.5)

High Speed, High Current Switching Applications

Features

- Low Drain-Source ON Resistance
 - $R_{DS(ON)} = 1.1\Omega$ (Typ.)
- High Forward Transfer Admittance
 - $|Y_{fs}| = 4.0S$ (Typ.)
- Low Leakage Current
 - $I_{DSS} = 300\mu A$ (Max.) @ $V_{DS} = 720V$
- Enhancement-Mode
 - $V_{th} = 1.5 \sim 3.5 V @ V_{DS} = 10 V, I_{D} = 1 mA$

Absolute Maximum Ratings (Ta = 25°C)

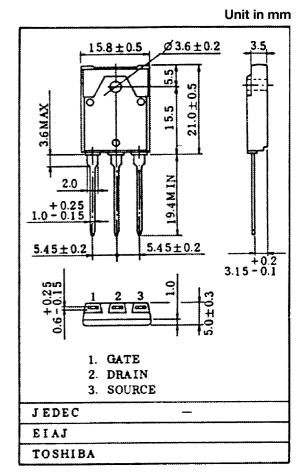
CHARACTERISTIC		SYMBOL	RATING	UNIT	
Drain-Source Voltage		V _{DSS}	900	٧	
Drain-Gate Voltage ($R_{GS} = 20k\Omega$)		V _{DGR}	900	V	
Gate-Source Voltage		V _{GSS}	±30	V	
Drain Current	DC	I _D	8		
	Pulse	I _{DP}	24	А	
Drain Power Dissipation (Tc = 25°C)		P _D	90	W	
Channel Temperature		T _{ch}	150	°C	
Storage Temperature		T _{stg}	-55 ~ 150	°C	

Thermal Characteristics

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	R _{th(ch-c)}	1.39	°C/W
Thermal Resistance, Channel to Ambient	R _{th(ch-a)}	41.6	°C/W

This transister is an electrostatic sensitive device.

Please handle with caution.



1/2

Electrical Characteristics (Ta = 25°C)

CHARA	CTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I _{GSS}	$V_{GS} = \pm 25V, V_{DS} = 0V$	-	-	±100	nA
Drain Cut-off Current		I _{DSS}	V _{DS} = 720V, V _{GS} = 0V	-	-	300	μА
Drain-Source Breakdown Voltage V		V _{(BR) DSS}	$I_D = 10$ mA, $V_{GS} = 0$ V	900	-	-	٧
Gate Threshold Voltage		V _{th}	$V_{DS} = -10V, I_{D} = -1mA$	1.5	-	3.5	V
Drain-Source ON Resistance R _{DS (ON)} I _D = 4		I _D = 4A, V _{GS} = 10V	-	1.1	1.4	Ω	
Forward Transfer	Admittance	Y _{fs}	V _{DS} = 20V, I _{DS} = 4A	2.0	4.0	-	S
Input Capacitance		C _{iss}	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz	-	1300	1800	pF
Reverse Transfer Capacitance		C _{rss}		-	100	150	
Output Capacitance		C _{oss}		-	180	260	
	Rise Time	tr	10V VIN ID=3A VOUT	-	25	50	ns
Switching Time	Turn-on Time	t _{on}		-	40	80	
	Fall Time	t _f		-	20	40	
	Turn-off Time	t _{off}	$V_{\text{IN}}: t_{\text{f}}, t_{\text{f}} < 5_{\text{ns}}$ $V_{\text{DD}} \neq 200 \text{ V}$ $0.0 \leq 1\% \ (Z_{\text{OUT}} = 50\Omega)$	-	100	200	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Qg	$V_{DD} = 400V, V_{GS} = -10V,$ $I_{D} = 9A$	-	120	240	nC
Gate-Source Charge		Q_{gs}		_	70	-	
Gate-Drain ("Miller") Charge		Q_{gd}		-	50	-	

Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I _{DR}	_	-	-	9	Α
Pulse Drain Reverse Current	I _{DRP}	_	-	-	27	Α
Diode Forward Voltage	V _{DSF}	I _{DR} = 9A, V _{GS} = 0V	-	-	-2.0	٧

The information contained here is subject to change without notice.

The information contained herein is presented only as guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of TOSHIBA or others. These TOSHIBA products are intended for usage in general electronic equipments, communication equipment, measuring equipment, domestic electrification, etc.) Please make sure that you consult with us before you use these TOSHIBA products in equipments which require high quality and/or reliability, and in equipments which rould have major impact to the welfare of human life (atomic energy control, paceship, traffic signal, combustion control, all types of safety devices, etc.). TOSHIBA cannot accept liability to any damage which may occur in case these TOSHIBA products were used in the mentioned equipments without prior consultation with TOSHIBA.

2/2 TOSHIBA CORPORATION

This datasheet has been downloaded from:

www. Data sheet Catalog.com

Datasheets for electronic components.